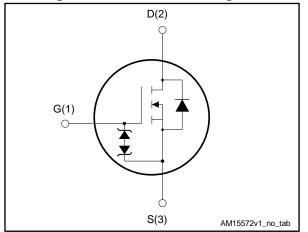


N-channel 600 V, 550 mΩ typ., 8 A MDmesh[™] DM2 Power MOSFET in a TO-220FP package

Datasheet - production data

TO-220FP

Figure 1: Internal schematic diagram



Features

Order code	VDS	RDS(on) max.	ΙD	Ртот
STF8N60DM2	600 V	600 mΩ	8 A	25 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmesh[™] DM2 fast recovery diode series. It offers very low recovery charge (Qrr) and time (tr) combined with low R_{DS(on)}, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STF8N60DM2	8N60DM2	TO-220FP	Tube

DocID027864 Rev 2

This is information on a product in full production.

Contents

Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e information	9
	4.1	TO-220FP package information	10
5	Revisio	on history	12



1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
ID ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	8	٨
ID('	Drain current (continuous) at T _{case} = 100 °C	5	A
I _{DM} ⁽²⁾	Drain current (pulsed)	32	А
P _{TOT}	Total dissipation at T _{case} = 25 °C	25	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	v/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_c = 25$ °C)	2.5	kV
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	–55 to 150	C

Notes:

⁽¹⁾ Current is limited by package.

 $^{\left(2\right) }$ Pulse width is limited by safe operating area.

 $^{(3)}$ Isp ≤ 8 A, di/dt=900 A/µs; Vps peak < V(BR)pss, Vpp = 400 V.

 $^{(4)}$ V_{DS} \leq 480 V.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR} ⁽¹⁾	Avalanche current, repetitive or not repetitive	2.5	А
E _{AS} ⁽²⁾	Single pulse avalanche energy	430	mJ

Notes:

 $^{\left(1\right) }$ Pulse width limited by $T_{jmax}.$

 $^{(2)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	600			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{case} = 125 \ ^{\circ}C^{(1)}$			100	μA
Igss	Gate-body leakage current	$V_{DS} = 0 V$, $V_{GS} = \pm 25 V$			±5	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4 \text{ A}$		550	600	mΩ

Notes:

 $\ensuremath{^{(1)}}\xspace$ Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	449	-	
Coss	Output capacitance	$V_{DS} = 100 V$, f = 1 MHz,	-	24	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V	-	0.89	-	2
Coss eq. ⁽¹⁾	Equivalent output capacitance	$V_{\text{DS}}=0 \text{ to } 480 \text{ V}, V_{\text{GS}}=0 \text{ V}$	-	42	-	pF
Rg	Intrinsic gate resistance	$f = 1 MHz$, $I_D = 0 A$	-	6.5	-	Ω
Qg	Total gate charge	$V_{DD} = 480 V, I_D = 8 A,$	-	13.5	-	
Qgs	Gate-source charge	V _{GS} = 10 V (see Figure 15: "Test circuit for gate charge	-	3	-	nC
Q_{gd}	Gate-drain charge	behavior")	-	7.7	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

	I	able 7. Switching times				1
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 4 A	-	10	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	6	-	
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	25.4	-	ns
t _f	Fall time	and Figure 19: "Switching time waveform")	-	9.5	-	

Table 7: Switching times



^{4/13}

Electrical characteristics

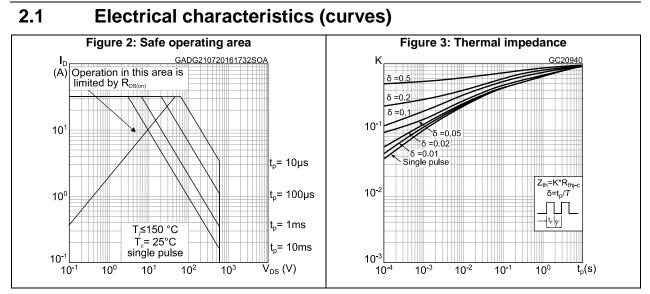
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		8	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		32	А
Vsd ⁽²⁾	Forward on voltage	$V_{GS} = 0 V$, $I_{SD} = 8 A$	-		1.6	V
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	80		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load	-	188		nC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	4.7		A
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	160		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	640		nC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	8		A

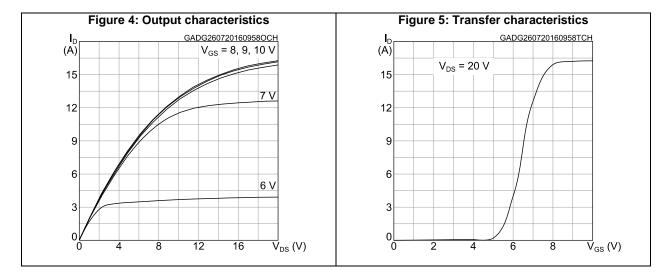
Notes:

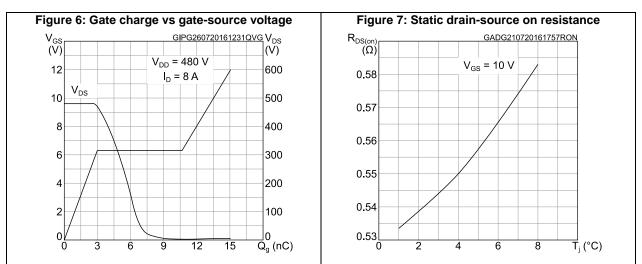
 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.







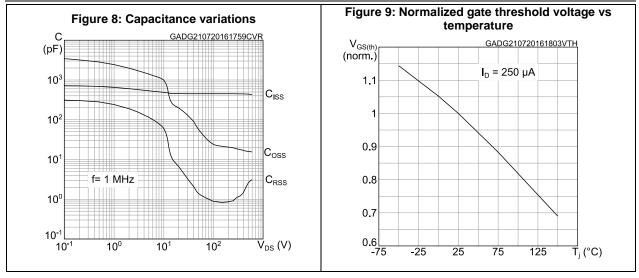


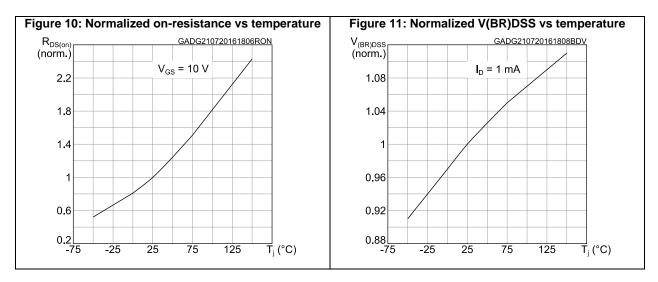
6/13

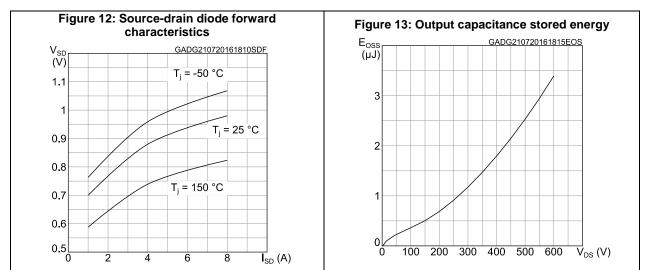


57

Electrical characteristics



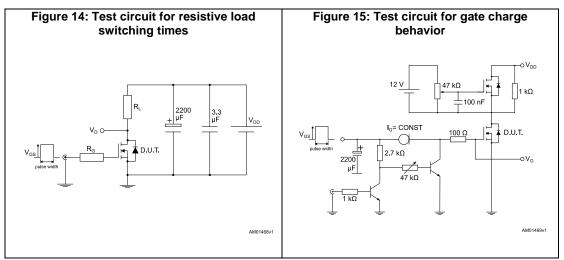


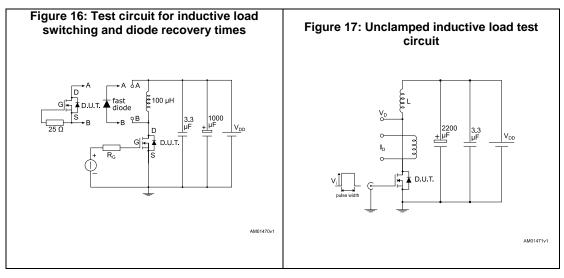


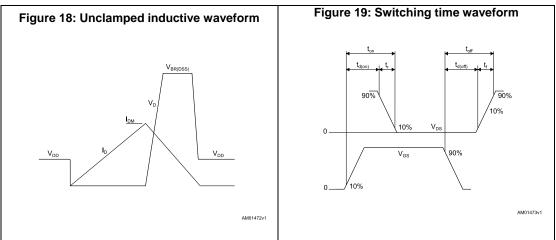
DocID027864 Rev 2

7/13

3 Test circuits







8/13

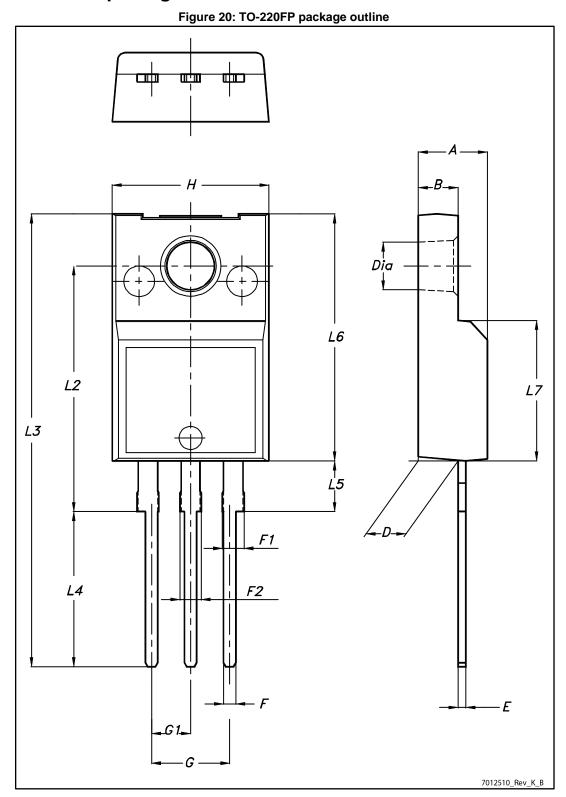


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 TO-220FP package information



10/13



Dia

_

3.2

/12			Package information
	Table 9: TO-220FP page	ckage mechanical da	ita
Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3

3



5 Revision history

Date	Revision	Changes
12-May-2015	1	First release.
24-Nov-2016	2	Document status promoted from preliminary to production data. Updated title in cover page, Section 1: "Electrical ratings", Section 2: "Electrical characteristics". Added Section 2.1: "Electrical characteristics (curves)".



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics - All rights reserved



单击下面可查看定价,库存,交付和生命周期等信息

>>STMicro(意法半导体)